

# BUL381 BUL382 HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- STM PREFERRED SALESTYPES
- HIGH VOLTAGE CAPABILITY
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERISED AT 125°C

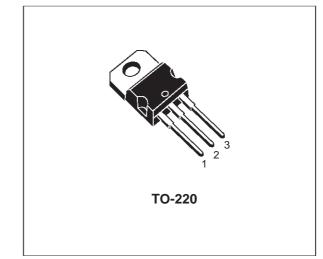
#### **APPLICATIONS**

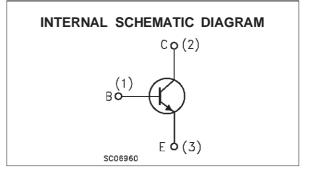
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

#### DESCRIPTION

The BUL381 and BUL382 manufactured using high voltage Multiepitaxial Mesa technology for cost-effective high performance. They use a Hollow Emitter structure to enhance switching speeds.

The BUL series is designed for use in lighting applications and low cost switch-mode power supplies.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
VCES	Collector-Emitter Voltage (V <sub>BE</sub> = 0)	800	V
VCEO	Collector-Emitter Voltage $(I_B = 0)$	400	V
V <sub>EBO</sub>	Emitter-Base Voltage $(I_C = 0)$	9	V
Ic	Collector Current	5	А
Ісм	Collector Peak Current (t <sub>p</sub> < 5 ms)	8	Α
IB	Base Current	2	Α
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> < 5 ms)	4	Α
P <sub>tot</sub>	Total Dissipation at $T_c = 25$ °C	70	W
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

## THERMAL DATA

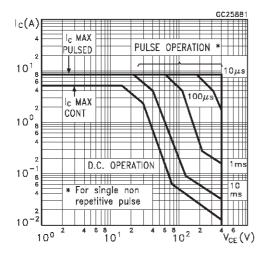
R <sub>thj</sub> -case			Junction-Case Junction-Ambient	Max	1.78 62.5	°C/W °C/W	
$R_{thj-amb}$	Inemai	Resistance	Junction-Ambient	Max	02.5	C/ VV	

# **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 $^{\circ}$ C unless otherwise specified)

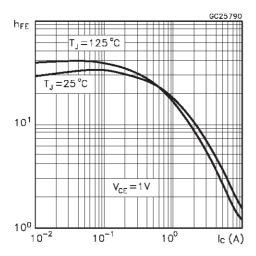
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector Cut-off Current (V <sub>BE</sub> = 0)				100 500	μΑ μΑ
I <sub>CEO</sub>	Collector Cut-off Current ( $I_B = 0$ )	V <sub>CE</sub> = 400 V			250	μA
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	$I_{C} = 100 \text{ mA}$ L = 25 mH	400			V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	I <sub>E</sub> = 10 mA	9			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage				0.5 0.7 1.1	V V V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	$I_{C} = 1 A$ $I_{B} = 0.2 A$ $I_{C} = 2 A$ $I_{B} = 0.4 A$			1.1 1.2	V V
h <sub>FE</sub> *	DC Current Gain		8 10			
t <sub>ON</sub> t <sub>s</sub> t <sub>f</sub>	RESISTIVE LOAD Turn-on Time Storage Time Fall Time		1.4		1 2.2 800	μs μs ns
ton t <sub>s</sub> t <sub>f</sub>	RESISTIVE LOAD Turn-on Time Storage Time Fall Time	$ \begin{array}{l} V_{CC} = 250 \ V  I_C = 2 \ A \\ I_{B1} = 0.4 \ A  I_{B2} = -0.4 \ A \\ (for \ BUL382 \ only) \\ t_p = 30 \ \mu s \end{array} $	1.7		1 2.5 800	μs μs ns
ts tf	INDUCTIVE LOAD Storage Time Fall Time			1.7 75	2.6 120	μs ns
ts tf	INDUCTIVE LOAD Storage Time Fall Time	$      I_C = 2 \ A  V_{CL} = 250 \ V \\      I_{B1} = 0.4 \ A  I_{B2} = -0.8 \ A \\      L = 200 \ \mu H  T_j = 125 \ ^{o}C $		2.6 150		μs ns

\* Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

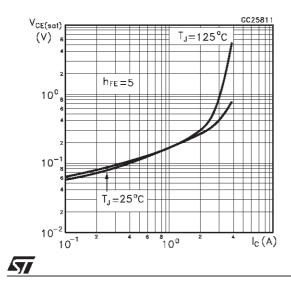
#### Safe Operating Areas



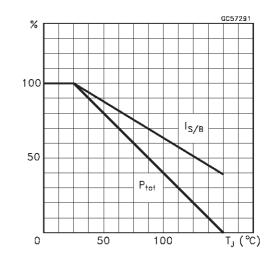
## DC Current Gain



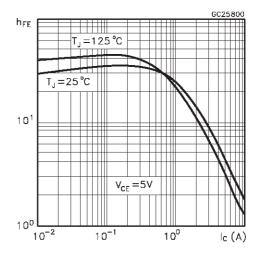
#### Collector Emitter Saturation Voltage



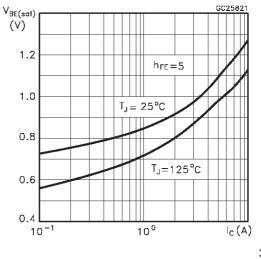
#### **Derating Curves**



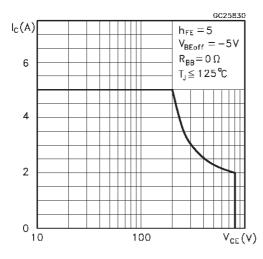
#### DC Current Gain



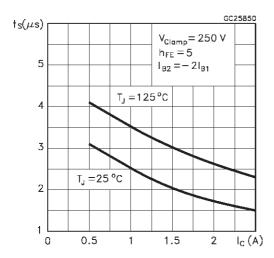




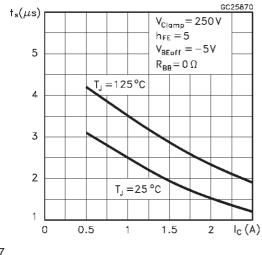
#### **Reverse Biased SOA**



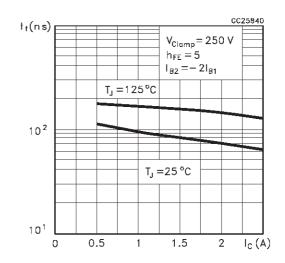
#### Inductive Storage Time



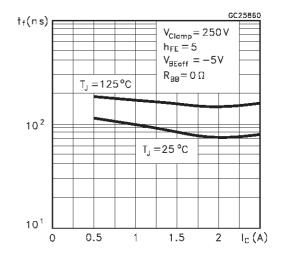
#### Inductive Storage Time



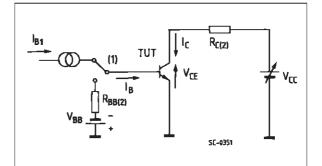
Inductive Fall Time



#### Inductive Fall Time



Resistive Load Switching Test Ciurcuit

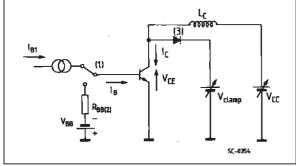


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- 1) Fast electronic switch
- 2) Non-inductive Resistor



#### Reverse BSOA and Inductive Load Switching **Test Ciurcuit**



1) Fast electronic switch

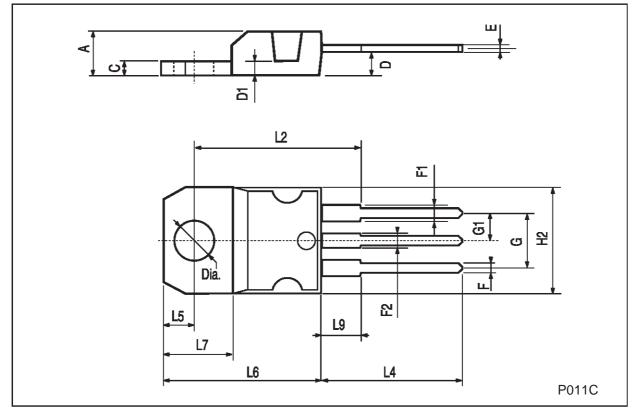
- 2) Non-inductive Resistor
  3) Fast recovery Rectifier



# BUL381 / BUL382

DIM.		mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.40		4.60	0.173		0.181	
С	1.23		1.32	0.048		0.051	
D	2.40		2.72	0.094		0.107	
D1		1.27			0.050		
E	0.49		0.70	0.019		0.027	
F	0.61		0.88	0.024		0.034	
F1	1.14		1.70	0.044		0.067	
F2	1.14		1.70	0.044		0.067	
G	4.95		5.15	0.194		0.203	
G1	2.4		2.7	0.094		0.106	
H2	10.0		10.40	0.393		0.409	
L2		16.4			0.645		
L4	13.0		14.0	0.511		0.551	
L5	2.65		2.95	0.104		0.116	
L6	15.25		15.75	0.600		0.620	
L7	6.2		6.6	0.244		0.260	
L9	3.5		3.93	0.137		0.154	
DIA.	3.75		3.85	0.147		0.151	





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